

NP90N06VDK

60 V – 90 A – N-channel Power MOS FET

R07DS1297EJ0100

Rev.1.00

Oct 26, 2015

Application: Automotive

Description

NP90N06VDK is N-channel MOS Field Effect Transistor designed for high current switching applications.

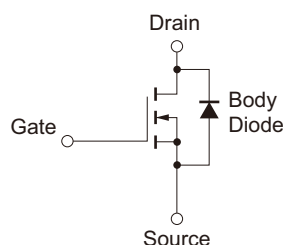
Features

- Super low on-state resistance
— $R_{DS(on)1} = 5.3 \text{ m}\Omega \text{ MAX.}$ ($V_{GS} = 10 \text{ V}$, $I_D = 45 \text{ A}$)
- Low C_{iss} : $C_{iss} = 4000 \text{ pF TYP.}$ ($V_{DS} = 25 \text{ V}$)
- Designed for automotive application and AEC-Q101 qualified

Outline



TO-252(MP-3ZP)



Equivalent circuit

Remark: Strong electric field, when exposed to this device, can cause destruction of the gate oxide and ultimately degrade the device operation. Steps must be taken to stop generation of static electricity as much as possible, and quickly dissipate it once, when it has occurred.

Ordering Information

Part No.	Lead Plating	Packing		Package
NP90N06VDK-E1-AY *1	Pure Sn (Tin)	Tape 2500 p/reel	Taping (E1 type)	TO-252(MP-3ZP)
NP90N06VDK-E2-AY *1			Taping (E2 type)	

Note: *1. Pb-free (This product does not contain Pb in the external electrode)

Absolute Maximum Ratings ($T_A = 25^\circ\text{C}$)

Item	Symbol	Ratings	Unit
Drain to Source Voltage ($V_{GS} = 0\text{ V}$)	V_{DSS}	60	V
Gate to Source Voltage ($V_{DS} = 0\text{ V}$)	V_{GSS}	± 20	V
Drain Current (DC) ($T_C = 25^\circ\text{C}$)	$I_{D(DC)}$	± 90	A
Drain Current (pulse) ^{*1}	$I_{D(pulse)}$	± 360	A
Total Power Dissipation ($T_C = 25^\circ\text{C}$)	P_{T1}	147	W
Total Power Dissipation ($T_A = 25^\circ\text{C}$)	P_{T2}	1.2	W
Channel Temperature	T_{ch}	175	$^\circ\text{C}$
Storage Temperature	T_{stg}	-55 to $+175$	$^\circ\text{C}$
Repetitive Avalanche Current ^{*2}	I_{AR}	33	A
Repetitive Avalanche Energy ^{*2}	E_{AR}	108	mJ

Notes: *1. $T_C = 25^\circ\text{C}$, $PW \leq 10\text{ }\mu\text{s}$, Duty Cycle $\leq 1\%$

*2. $R_G = 25\text{ }\Omega$, $V_{GS} = 20\text{ V} \rightarrow 0\text{ V}$

Thermal Resistance

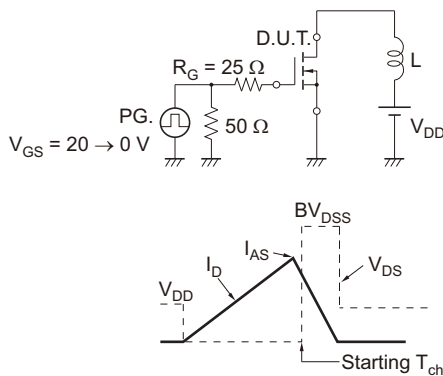
Channel to Case Thermal Resistance	$R_{th(ch-C)}$	1.02	$^\circ\text{C/W}$
Channel to Ambient Thermal Resistance	$R_{th(ch-A)}$	125	$^\circ\text{C/W}$

Electrical Characteristics (T_A = 25°C)

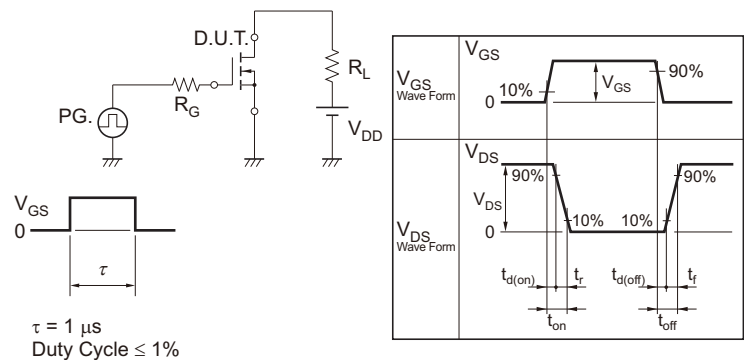
Item	Symbol	Min	Typ	Max	Unit	Test Conditions
Zero Gate Voltage Drain Current	I _{DSS}			1	μA	V _{DS} = 60 V, V _{GS} = 0 V
Gate Leakage Current	I _{GSS}			±100	nA	V _{GS} = ±20 V, V _{DS} = 0 V
Gate to Source Threshold Voltage	V _{GS(th)}	1.5	2.1	2.5	V	V _{DS} = V _{GS} , I _D = 250 μA
Forward Transfer Admittance *1	y _{fs}	40	80		S	V _{DS} = 5 V, I _D = 45 A
Drain to Source On-state Resistance *1	R _{DS(on)1}		3.8	5.3	mΩ	V _{GS} = 10 V, I _D = 45 A
	R _{DS(on)2}		4.9	8.2	mΩ	V _{GS} = 4.5 V, I _D = 23 A
Input Capacitance	C _{iss}		4000	6000	pF	V _{DS} = 25 V, V _{GS} = 0 V, f = 1 MHz
Output Capacitance	C _{oss}		360	540	pF	
Reverse Transfer Capacitance	C _{rss}		110	200	pF	
Turn-on Delay Time	t _{d(on)}		24	60	ns	V _{DD} = 30 V, I _D = 45 A, V _{GS} = 10 V, R _G = 0 Ω
Rise Time	t _r		7	20	ns	
Turn-off Delay Time	t _{d(off)}		60	120	ns	
Fall Time	t _f		6	20	ns	
Total Gate Charge	Q _G		63	95	nC	V _{DD} = 48 V, V _{GS} = 10 V, I _D = 90 A
Gate to Source Charge	Q _{GS}		15		nC	
Gate to Drain Charge	Q _{GD}		12		nC	
Body Diode Forward Voltage *1	V _{F(S-D)}		0.9	1.5	V	I _F = 90 A, V _{GS} = 0 V
Reverse Recovery Time	t _{rr}		40		ns	I _F = 90 A, V _{GS} = 0 V, di/dt = 100 A/μs
Reverse Recovery Charge	Q _{rr}		45		nC	

Note: *1. Pulsed test

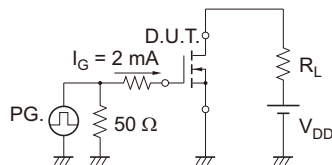
TEST CIRCUIT 1 AVALANCHE CAPABILITY



TEST CIRCUIT 2 SWITCHING TIME

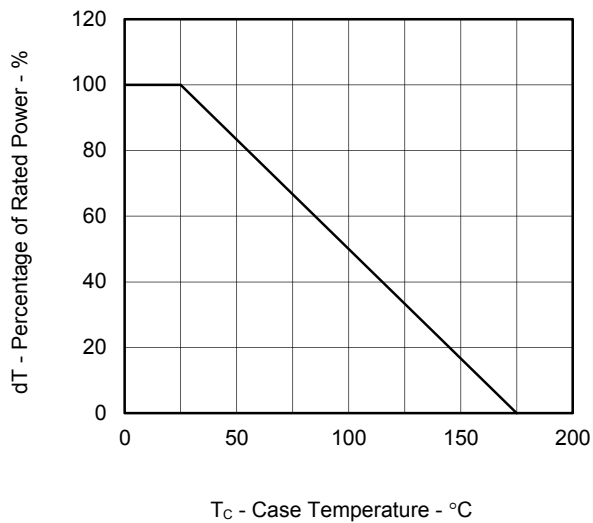


TEST CIRCUIT 3 GATE CHARGE

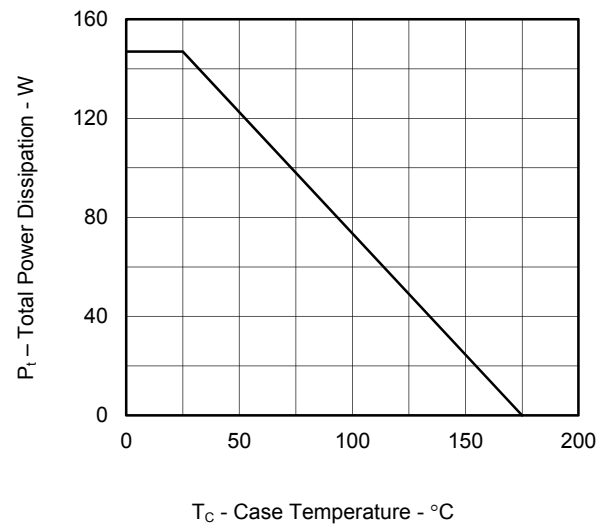


Typical Characteristics ($T_A = 25^\circ\text{C}$)

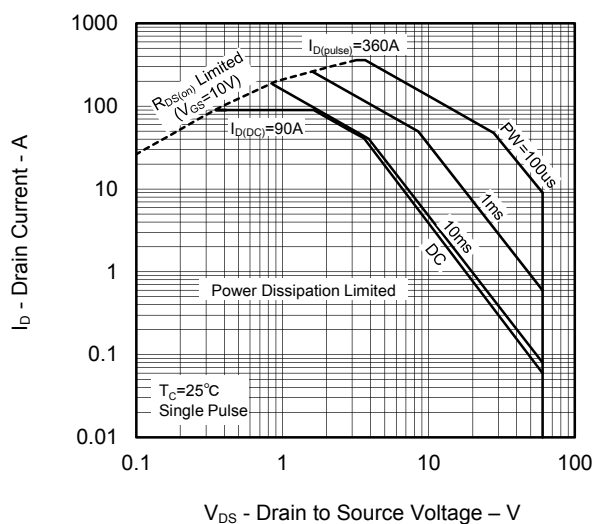
DERATING FACTOR OF FORWARD BIAS SAFE OPERATING AREA



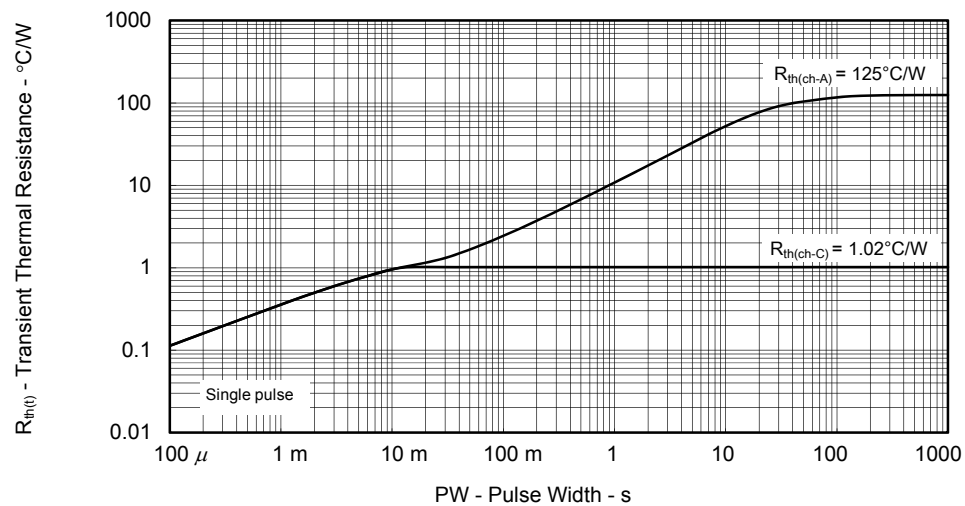
TOTAL POWER DISSIPATION vs. CASE TEMPERATURE

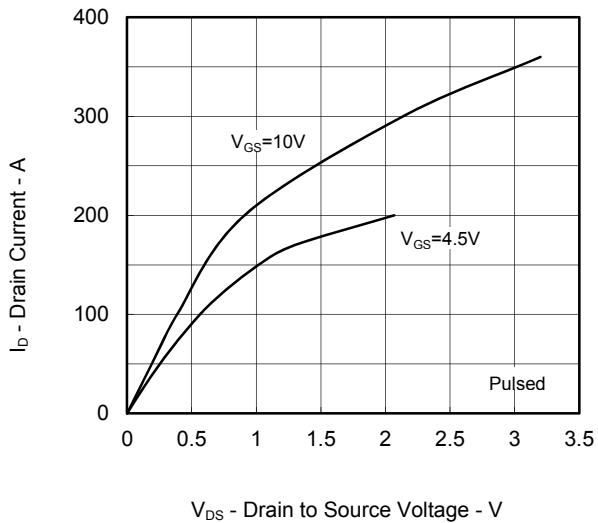


FORWARD BIAS SAFE OPERATING AREA

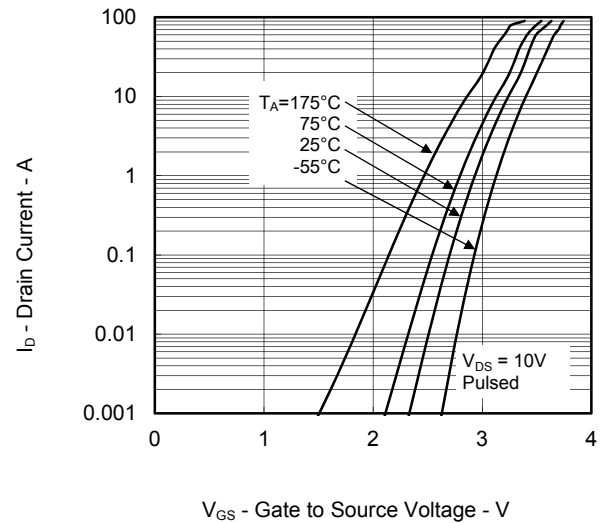
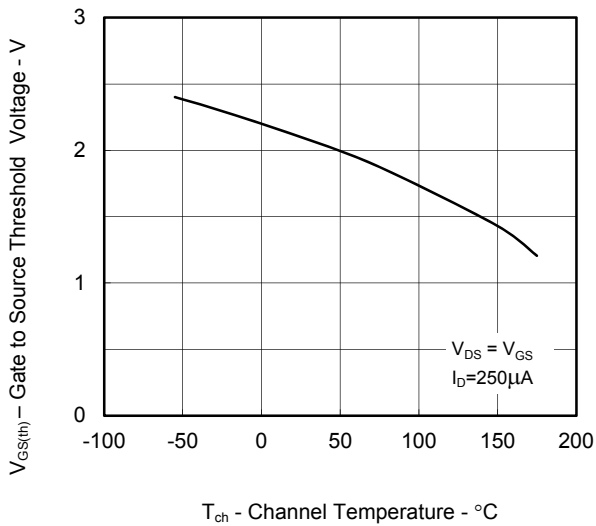
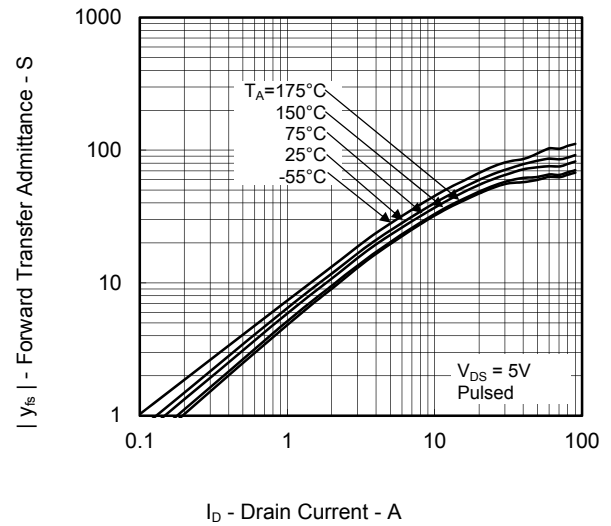
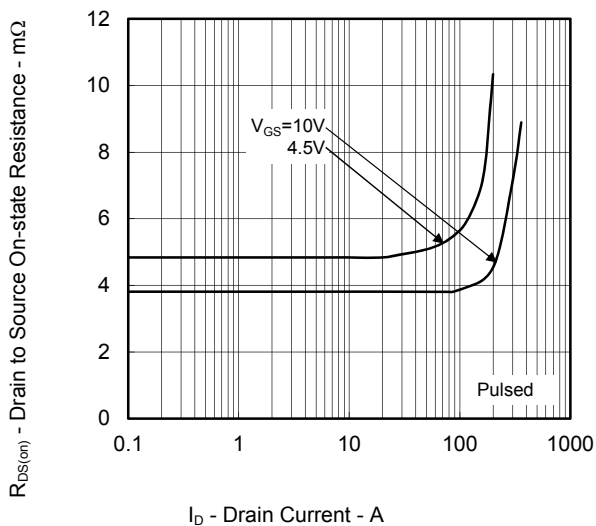
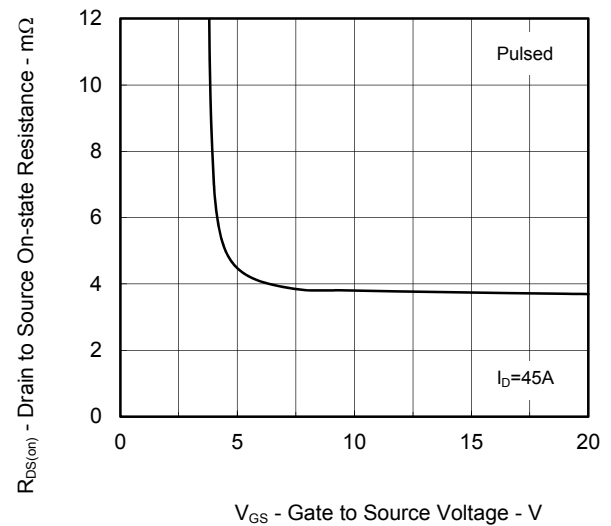


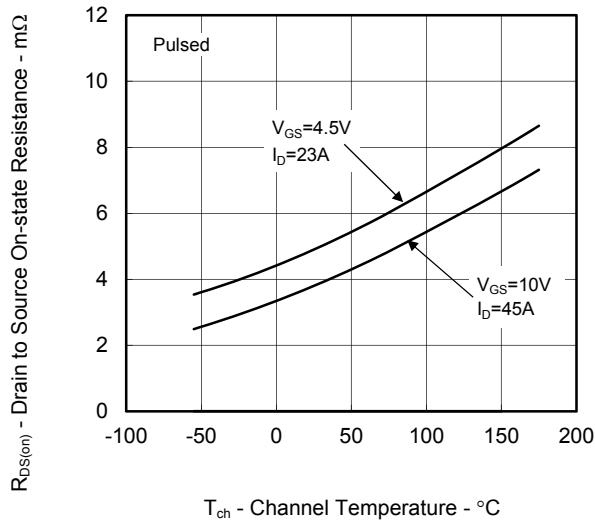
TRANSIENT THERMAL RESISTANCE vs. PULSE WIDTH



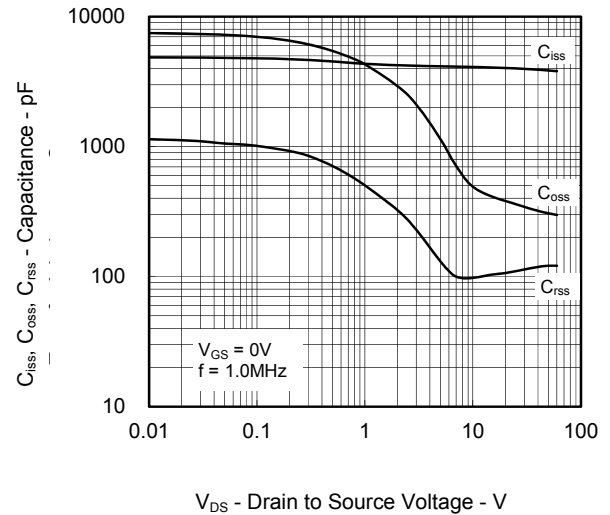
DRAIN CURRENT vs.
DRAIN TO SOURCE VOLTAGE

FORWARD TRANSFER CHARACTERISTICS

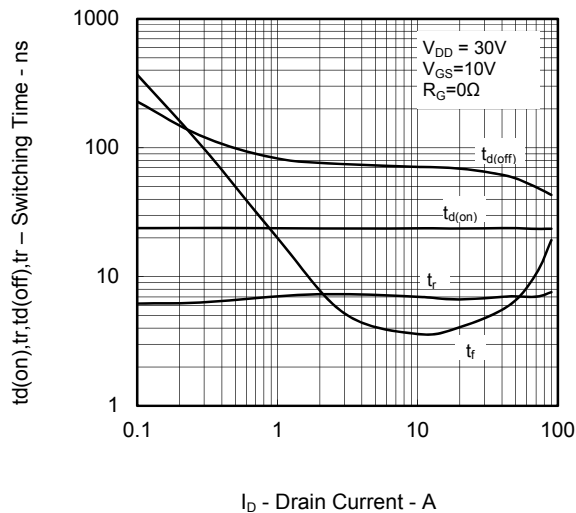
GATE TO SOURCE THRESHOLD VOLTAGE vs.
CHANNEL TEMPERATUREFORWARD TRANSFER ADMITTANCE vs. DRAIN
CURRENTDRAIN TO SOURCE ON-STATE RESISTANCE vs.
DRAIN CURRENTDRAIN TO SOURCE ON-STATE RESISTANCE vs.
GATE TO SOURCE VOLTAGE

DRAIN TO SOURCE ON-STATE RESISTANCE vs.
CHANNEL TEMPERATURE

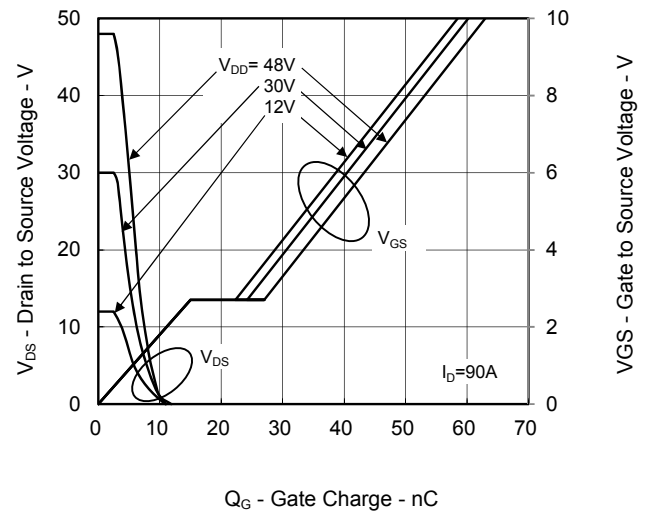
CAPACITANCE vs. DRAIN TO SOURCE VOLTAGE



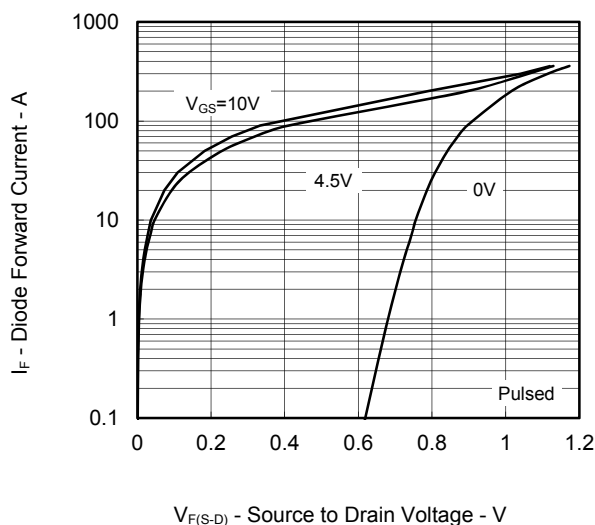
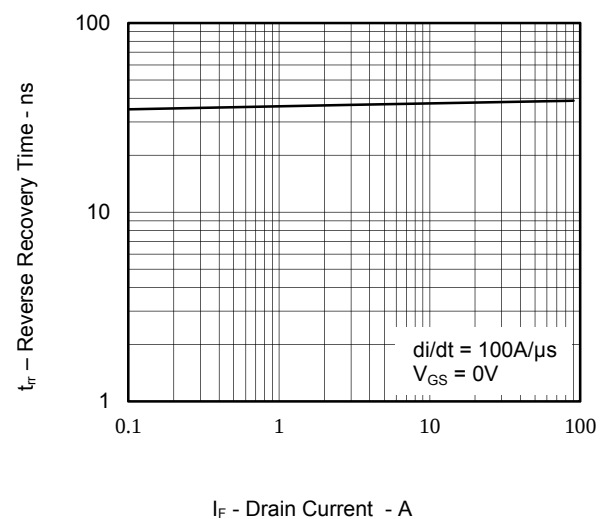
SWITCHING CHARACTERISTICS



DYNAMIC INPUT CHARACTERISTICS

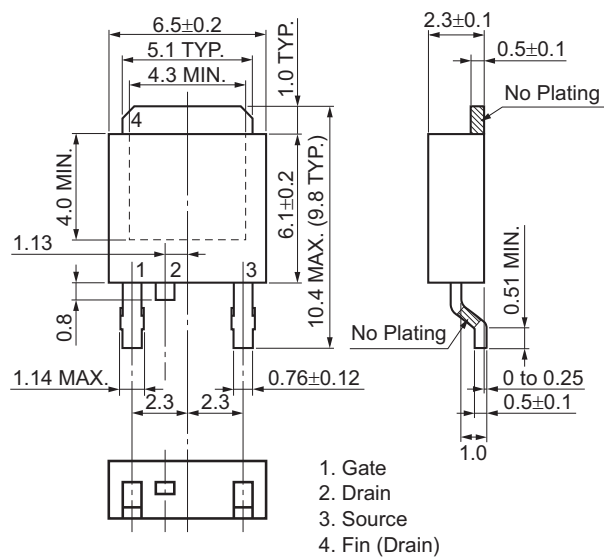


SOURCE TO DRAIN DIODE FORWARD VOLTAGE

REVERSE RECOVERY TIME vs.
DRAIN CURRENT

Package Drawings (Unit: mm)**TO-252 (MP-3ZP) (Mass: 0.3 g TYP.)**

Renesas package code: PRSS0004ZP-A



Revision History	NP90N06VDK Data Sheet
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Rev.	Date	Description	
		Page	Summary
1.00	Oct. 26, 2015	—	First Edition Issued

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